

HE-LINK 80km XFP ZR Optical Transceiver

Features

- XFP MSA Rev 4.5 Compliant
- Data rate from 9.95Gbps to 11.3Gbps
- No Reference Clock required
- Cooled 1550 nm EML and APD receiver
- link length up to 80km
- +1.8V,+3.3V,+5V Supply Voltage
- Low Power Dissipation 3.5W Maximum
- XFI and lineside loopback Mode Supported
- -5°C to 70°C Operating Case Temperature
- Diagnostic Performance Monitoring of module temperature, Supply Voltages, laser bias current, transmit optical power, and receive optical power
- RoHS6 compliant (lead free)



Applications

- SONET OC-192&SDH STM 64 (with/with out FEC)
- 10GBASE ZR/ZW (with/with out FEC)
- 10G Fiber Channel

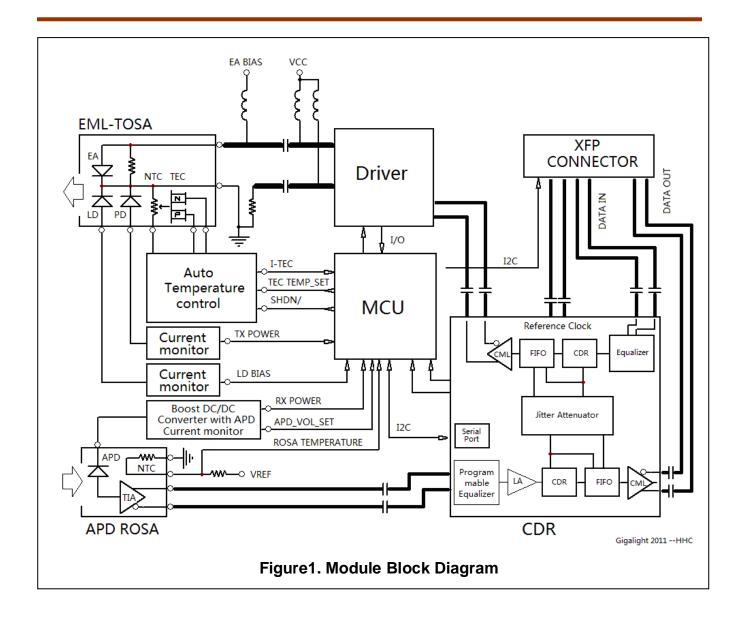
Description

HE-LINK 80km XFP Transceiver exhibits excellent wavelength stability, Designed for 10G SDH/SONET, 10GBASE-ZR and 10G Fiber- Channel applications.

The transceiver consists of two sections: The transmitter section incorporates a colded EML laser. And the receiver section consists of a APD photodiode integrated with a TIA. All modules satisfy class I laser safety requirements. HE-LINK XFP transceiver provides an enhanced monitoring interface, which allows real-time access to device operating parameters such as transceiver temperature, laser bias current, transmitted optical power, received optical power and transceiver supply voltage.

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Absolute Maximum Ratings

Parameter	Symbol	Min	Max	Unit
Supply Voltage 1	Vcc3	-0.5	4.0	V
Supply Voltage 2	Vcc5	-0.5	6.0	V
Supply Voltage 3	Vcc2	-0.5	2	V
Storage Temperature	Tst	-40	85	°C
Case Operating Temperature	Тор	-5	70	°C

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Operating Conditions

Parameter	Symbol	Min	Typical	Max	Unit
Supply Voltage 1	Vcc3	3.13	3.3	3.47	V
Supply current 1	lcc3	-	-	750	mA
Supply Voltage 2	Vcc5	4.75	5	5.25	V
Supply current 2	Icc5	-	-	500	mA
Supply Voltage 3	Vcc2	1.71	1.8	1.89	V
Supply current 3	lcc2	-	-	750	mA
Operating Case temperature	Tca	-5	-	70	°C
Module Power Dissipation	Pm	-	-	3.5	W

Transmitter Specifications – Optical

Parameter	Symbol	Min	Typical	Max	Unit
Center Wavelength [1]	λο	1530		1565	pm
Optical Transmit Power	Po	0	-	+4	dBm
Optical Transmit Power (disabled)	PTX_DIS	-	-	-30	dBm
Extinction Ratio	ER	9	-	-	dB
Jitter Generation(P-P)	JG P-P	-	-	0.1	UI
Jitter Generation(RMS)	JG RMS	-	-	0.01	UI
Spectral Width (-20dB)	Δ λ 20	-	-	0.3	nm
Side Mode Suppression Ratio	SMSR	30	-	-	dB
Dispersion penalty(2400ps/nm) [2]	DP	-	-	2	dB
Relative Intensity Noise	RIN	-	-	-130	dB/Hz
Eye Mask		Compliant with	ı ITU-T G.691 STI	M-64 eye mask	

Note:

- 1. Wavelength stability is achieved within 60 seconds (max) of power up.
- 2. BER=10^-12; PRBS 2^31-1@9.95Gbps

Transmitter Specifications – Electrical

Parameter	Symbol	Min	Typical	Max	Unit
Input differential impedance	Rim	-	100	-	Ω
Differential data Input	VtxDIFF	120	-	850	mV
Transmit Disable Voltage	VD	2.0	-	Vcc3+0.3	V
Transmit Enable Voltage	Ven	0	-	+0.8	V
Transmit Disable Assert Time	Vn	-	-	10	us

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Receiver Specifications - Optical

Parameter	Symbol	Min	Typical	Max	Unit
Receiver Sensitivity~9.95Gb/s [1]	Rsen1	-	-	-24	dBm
Receiver Sensitivity~11.3Gb/s [1]	Rsen2	-	-	-23	dBm
Maximum Input Power	RX-overload	-7	-	-	dBm
Input Operating Wavelength	λ	1270	-	1600	nm
Reflectance	Rrx	-	-	-27	dB
Loss of Signal Asserted	LOS_A	-34	-	-	dBm
Path penalty at 1600 ps/nm~9.95Gb/s	DP1			2	dBm
Path penalty at 1600 ps/nm~10.7Gb/s	DP2			3	dBm
Path penalty at 1450 ps/nm~11.3Gb/s	DP3			3	dBm
Loss of Signal Asserted	LOS_A	-34	-	-	dBm
LOS De-Asserted	LOS_D	-	-	-24	dBm
LOS Hysteresis	LOS_H	0.5	-	-	dB

Note:

1. BER=10^-12, PRBS 2^31-1

Receiver Specifications – Electrical

Parameter	Symbol	Min	Typical	Max	Unit
Output differential impedance	Rom	-	100		Ω
Differential Output Swing	Vout P-P	350	-	850	mV
Rise/Fall Time [1]	Tr / Tf	24	-	-	ps
Loss of Signal –Asserted	VOH	2	-	Vcc3+0.3-	V
Loss of Signal –Negated	VOL	GND	-	GND+0.5	V

Note:

1. 20%-80%;

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Pin Descriptions

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Pin	Logic	Symbol	Name/Description	Ref.
1		GND	Module Ground	1
2		VEE5	Optional –5.2 Power Supply – Not required	
3	LVTTL-I	Mod-Desel	Module De-select; When held low allows the module to , respond to 2-wire serial interface commands	
4	LVTTL-O	Interrupt	Interrupt (bar); Indicates presence of an important condition which can be read over the serial 2-wire interface	2
5	LVTTL-I	TX_DIS	Transmitter Disable; Transmitter laser source turned off	
6		VCC5	+5 Power Supply	
7		GND	Module Ground	1
8		VCC3	+3.3V Power Supply	
9		VCC3	+3.3V Power Supply	
10	LVTTL-I	SCL	Serial 2-wire interface clock	2
11	LVTTL- I/O	SDA	Serial 2-wire interface data line	2
12	LVTTL-O	Mod_Abs	Module Absent; Indicates module is not present. Grounded in the module.	2
13	LVTTL-O	Mod_NR	Module Not Ready;	2
14	LVTTL-O	RX_LOS	Receiver Loss of Signal indicator	2
15		GND	Module Ground	1
16		GND	Module Ground	1
17	CML-O	RD-	Receiver inverted data output	
18	CML-O	RD+	Receiver non-inverted data output	
19		GND	Module Ground	1
20		VCC2	+1.8V Power Supply	
21	LVTTL-I	P_Down/RS T	Power Down; When high, places the module in the low power stand-by mode and on the falling edge of P_Down initiates a module reset Reset; The falling edge initiates a complete reset of the module including	
		'	the 2-wire serial interface, equivalent to a power cycle.	
22		VCC2	+1.8V Power Supply	
23		GND	Module Ground	1
24	PECL-I	RefCLK+	Reference Clock non-inverted input, AC coupled on the host board	3
25	PECL-I	RefCLK-	Reference Clock inverted input, AC coupled on the host board	3
26		GND	Module Ground	1
27		GND	Module Ground	1
28	CML-I	TD-	Transmitter inverted data input	
29	CML-I	TD+	Transmitter non-inverted data input	
30		GND	Module Ground	1

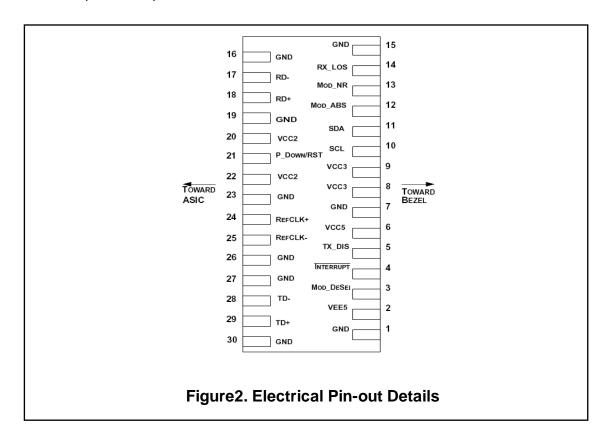
Notes:

1. Module circuit ground is isolated from module chassis ground within the module.

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- 2. Open collector; should be pulled up with 4.7k 10k ohms on host board to a voltage between 3.15Vand 3.6V.
- 3. Reference Clock input is not required.



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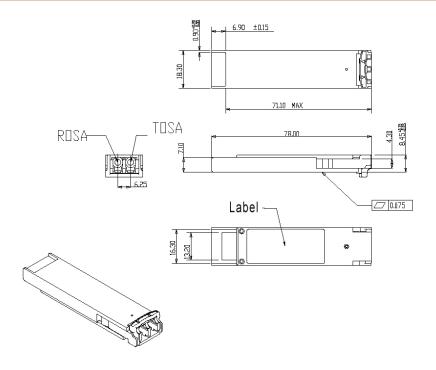


Figure 3. Mechanical Specifications

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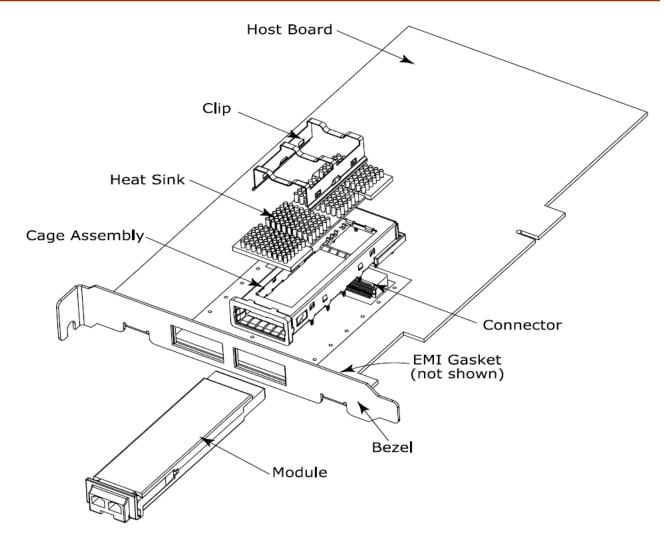


Figure 4. XFP Mechanical Components

The mechanical components defined:

- 1. The module, clip and connector dimensions are constant for all applications. While the bezel, cage assembly, EMI gasket and heat sink can be designed and/or adjusted for the individual application.
- 2. The relatively small form factor of the XFP module combined with an adaptable heatsink option allows host system design optimization of module location, heatsink shape/dimension/fins design, and airflow control. The module can be inserted and removed from the cage with the heat sink and clip attached.

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Regulatory Compliance

HE-LINK XFP transceiver is designed to be Class I Laser safety compliant and is certified per the following standards:

Feature	Agency	Standard	Certificate / Comments
Laser Safety	FDA	CDRH 21 CFR 1040 and Laser Notice No. 50	1120288-000
Product Safety	UL	UL and CUL EN60950-2:2007	E347511
Environmental protection	SGS	RoHS Directive 2002/95/EC	GZ1001008706/CHEM
EMC	WALTEK	EN 55022:2006+A1:2007 EN 55024:1998+A1+A2:2003 -	WT10093768-D-E-E

Ordering information

Part Number	Product Description
HL-XFP-ZR	1550nm, 10Gbps, XFP 80km, -5°C ~ +70°C

References

- 1. 10 Gigabit Small Form Factor Pluggable Module (XFP) Multi-Source Agreement (MSA), Rev 4.5 August 2005. Documentation is currently available at http://www.xfpmsa.org/
- 2. IEEE802.3ae 2002
- 3. ITU-T G.709 / ITU-T G.959.1 http://www.itu.int/
- 4. Telcordia GR-253-CORE

Important Notice

Performance figures, data and any illustrative material provided in this data sheet are typical and must be specifically confirmed in writing by HE-LINK before they become applicable to any particular order or contract. In accordance with the HE-LINK policy of continuous improvement specifications may change without notice.

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